

Electronic Patent Application Fee Transmittal

Application Number:	10091106			
Filing Date:	05-Mar-2002			
Title of Invention:	Defect reduction in electrodeposited copper for semiconductor applications			
First Named Inventor:	John Commander			
Filer:	Paul I.J. Fleischut/Lisa Buchhold			
Attorney Docket Number:	CEDE 2036			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 2 months with \$0 paid	1252	1	450	450

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				1240